

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: H. MATSUURA, et al.
Application No.: 10/519,713
Filed: DECEMBER 30, 2004
For: ADHESIVE FILM FOR SEMICONDUCTOR USE, METAL
SHEET LAMINATED WITH ADHESIVE FIL, WIRING CIRCUIT
LAMINATED WITH ADHESIVE FILM, AND SEMICONDUCTOR
Group AU: 2823
Examiner: Julio J. Maldonado
Confirm. No.: 7508

AMENDMENT

Mail Stop: AMEND - FEE

Commissioner for Patents
P.O. Box 1450
Alexandria, Virginia 22313-1450

September 17, 2007

Sir:

In response to the Office Action mailed May 15, 2007, the period for response having been extended for one (1) month by the attached Petition for Extension of Time, please amend the above-identified application as listed in the following, and as set forth on the following pages:

AMENDMENTS TO THE CLAIMS; and

REMARKS are included following the amendments.